OCT 1 4 2003 W FORM PTO-1595 (Rev. 10/02) Docket No : 60188-313

10-17-2003



102577211 PATENTS ONLY U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office

DUCKET NO.: 00100-313 PATENTS				
To the Honorable Commissioner for Patents and Trademarks: Ple	ease record t	he attached original documents or copy thereto:		
1. Name of Conveying Party(ies):	2. Name and address of receiving party(ies):			
Yasufumi SHIRAKAWA, Masaki TANIGUCHI, Hideo	Name:	MATSUSHITA ELECTRIC INDUSTRIAL CO.,		
FUKUDA, Yuzo SHIMIZU, and Shinya ESAKI		LTD.		
	Address:	1006, Oaza Kadoma		
Additional name(s) of conveying party(ies) attached?  Yes  No		Kadoma-shi		
3. Nature of Conveyance:		Osaka 571-8501, JAPAN		
☐ Assignment ☐ Merger				
☐ Security Agreement ☐ Change of Name				
Other Request for Correction of Notice of Recordation of Assignment Document				
Execution Date: March 13, 2003				
	Additional	name(s) & address(es) attached?  Yes No		
4. Application number(s) or patent number(s):				
If the document is being filed together with a new application, the e	xecution date	e of the application is:		
A. Patent Application No(s).	B. Patent l	No(s).		
10/388,617				
Additional numbers attached?  Yes No				
5. Name and address of party to whom correspondence	6. Total nu	umber of applications and patents involved: 1		
concerning document should be mailed:				
Name: MCDERMOTT, WILL & EMERY	7. Total fe	e (37 CFR 3.41) \$		
Internal Address:	☐ Enc	elosed		
	☐ Aut	horized to be charged to deposit account		
Street Address: 600 13th Street, N.W.	8. Deposit	account number:		
City: Washington State: D. C. Zip: 20005-3096				
DO NOT USE THIS SPACE				
9. Statement and signature.				
To the best of my knowledge and belief, the foregoing informa	ition is true c	and correct and any attached copy is a true copy		
of the original document.	0 ,			
Michael E. Fogarty, Reg. No. 36,139		October 14, 2003		
Name and Registration No. of Person Signing	Signature	Date		
	-/	of pages including cover sheet:		
OMB No. 0651-0027 (exp. 6/30/2005)	/			

03-28/2003

FORM PTO-1596 U.S. DEPARTMENT OF COMMERCE 1-31-92 Patent and Trademark Office Docket No.: 60188-313 To the Honorable Commissioner for Patents and Trademarks Please record the attached original documents or copy thereto: 1. Name of Conveying Party(ies): 2. Name and address of receiving party(ies): Yasufumi SHIRAKAWA, Masaki TANIGUCHI, Hideo Name: MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD. FUKUDA, Yuzo SHIMIZU, and Shinya ESAKI Address: 1006, Oaza Kadoma, Additional name(s) of conveying party(ies) attached? Kadoma-shi, Yes Osaka 571-8501 JAPAN 3. Nature of Conveyance: ★ Assignment Security Agreement Change of Name Other Execution Date: March 13, 2003 Additional name(s) & address(es) attached? Yes 4. Application number(s) or patent number(s): If the document is being filed together with a new application, the execution date of the application is: March 13, 2003 A. Patent Application No(s). B. Patent No(s). Additional numbers attached? Yes 5. Name and address of party to whom correspondence 6. Total number of applications and patents involved: concerning document should be mailed: Name: MCDERMOTT, WILL & EMERY 7. Total fee (37 CFR 3.41) \$40.00 Internal Address: Enclosed Authorized to be charged to deposit account Street Address: 600 13th Street, N.W. 8. Deposit account number: 500417 City: Washington State: DC Zip: 20005 DO NOT USE THIS SPACE 9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Michael E. Fogarty, 36,139 March 17, 2003 Name and Registration No. of Person Signing Signature Date otal number of pages comprising cover sheet: CMB No. 0851-0011 (exp. 4/94)

03/27/2003 TDIAZ1 00000150 500417 10388617 01 FC:8021 40.00 CH

Vasufumi SHIRAKAWA Masaki TANICIICHI Hideo

## ASSIGNMENT

WHEREAS

WILEKE, I agaitami Sittle Mill Will Will Will Will Will Will Will					
FUKUDA, Yuz	o SHIMIZU	J and Shinya ESAKI	(hereinafter designa	ated as the	
undersigned) ha	s (have) inv	vented certain new and us	seful improvements in INTE	<u>GRATED</u>	
CIRCUIT DEV	ICE INSTAI	LLED STRUCTURE AND	INSTALLATION METHOD		
for which the un	dersigned ha	as (have):			
(a) filed an application for Letters Patent of the United States of			of the United States of Americ	a on	
		having Se	erial No.	; or	
(b)		n application for Letters Pat icated below; and	ent of the United States of Ame	rica on the	
WHER	` ,	,	ric Industrial Co., Ltd.	of	
WHEREAS, <u>Matsushita Electric Industrial Co., Ltd.</u> of 1006, Oaza Kadoma, Kadoma-shi, Osaka 571-8501, Japan its					
desirous of acqu	iring the ent	_ `	ereinafter designated as the A in and to said invention and in ited States of America;	_ /	

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents do sell, assign and transfer unto the Assignee the full and exclusive right to the said invention in the United States of America and its territories and for all foreign countries, dependencies and possessions and the entire right, title and interest in and to the application and any and all Letters Patent(s) which may be granted therefor in the United States of America and its territories, dependencies and possessions, and in and to any and all divisions, reissues, continuations and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or any continuation, division or reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims under or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent(s) to the Assignee and to vest all rights therein hereby conveyed to the Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue any and all Letters Patents of the United States of America resulting from said applicationor any division or divisions or continuing or reissue applications thereof to the Assignee, as Assignee of the entire interest, and hereby convenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

This Assignment has been executed by the undersigned on the date(s) indicated.

Date: _		Yasufum Shinaban Yasufumi SHIRAKAWA
		<sup>7</sup> Yasufumi SHIRAKAWA
Date: _	March 13, 2003,	Masaki Taniquchi Masaki TANIGUCHI
		Hideo Trukuda
Date:		Hideo FUKUDA
Date:	March 13, 2003,	Yuzo Shimizu
		Yuzo SHIMIZU
Date:	March 13, 2003,	
		Shinya ESAKI
Date:		· ————————————————————————————————————
Date:		
Date:		

**RECORDED: 10/14/2003**